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### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	13
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	96 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	20-SSOP
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic16lc621at-04-ss">https://www.e-xfl.com/product-detail/microchip-technology/pic16lc621at-04-ss</a>

# PIC16C62X

**FIGURE 4-6: DATA MEMORY MAP FOR THE PIC16C620A/CR620A/621A**

File Address			File Address
00h	INDF <sup>(1)</sup>	INDF <sup>(1)</sup>	80h
01h	TMR0	OPTION	81h
02h	PCL	PCL	82h
03h	STATUS	STATUS	83h
04h	FSR	FSR	84h
05h	PORTA	TRISA	85h
06h	PORTB	TRISB	86h
07h			87h
08h			88h
09h			89h
0Ah	PCLATH	PCLATH	8Ah
0Bh	INTCON	INTCON	8Bh
0Ch	PIR1	PIE1	8Ch
0Dh			8Dh
0Eh		PCON	8Eh
0Fh			8Fh
10h			90h
11h			91h
12h			92h
13h			93h
14h			94h
15h			95h
16h			96h
17h			97h
18h			98h
19h			99h
1Ah			9Ah
1Bh			9Bh
1Ch			9Ch
1Dh			9Dh
1Eh			9Eh
1Fh	CMCON	VRCON	9Fh
20h	General Purpose Register		A0h
6Fh			F0h
70h	General Purpose Register	Accesses 70h-7Fh	F0h
7Fh			FFh
	Bank 0	Bank 1	

☐ Unimplemented data memory locations, read as '0'.

**Note 1:** Not a physical register.

**FIGURE 4-7: DATA MEMORY MAP FOR THE PIC16C622A**

File Address			File Address
00h	INDF <sup>(1)</sup>	INDF <sup>(1)</sup>	80h
01h	TMR0	OPTION	81h
02h	PCL	PCL	82h
03h	STATUS	STATUS	83h
04h	FSR	FSR	84h
05h	PORTA	TRISA	85h
06h	PORTB	TRISB	86h
07h			87h
08h			88h
09h			89h
0Ah	PCLATH	PCLATH	8Ah
0Bh	INTCON	INTCON	8Bh
0Ch	PIR1	PIE1	8Ch
0Dh			8Dh
0Eh		PCON	8Eh
0Fh			8Fh
10h			90h
11h			91h
12h			92h
13h			93h
14h			94h
15h			95h
16h			96h
17h			97h
18h			98h
19h			99h
1Ah			9Ah
1Bh			9Bh
1Ch			9Ch
1Dh			9Dh
1Eh			9Eh
1Fh	CMCON	VRCON	9Fh
20h	General Purpose Register	General Purpose Register	A0h
			BFh
			C0h
6Fh			F0h
70h	General Purpose Register	Accesses 70h-7Fh	F0h
7Fh			FFh
	Bank 0	Bank 1	

☐ Unimplemented data memory locations, read as '0'.

**Note 1:** Not a physical register.

# PIC16C62X

## 4.2.2.1 STATUS Register

The STATUS register, shown in Register 4-1, contains the arithmetic status of the ALU, the RESET status and the bank select bits for data memory.

The STATUS register can be the destination for any instruction, like any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the  $\overline{\text{TO}}$  and  $\overline{\text{PD}}$  bits are not writable. Therefore, the result of an instruction with the STATUS register as destination may be different than intended.

For example, `CLRF STATUS` will clear the upper-three bits and set the Z bit. This leaves the STATUS register as 000uu1uu (where u = unchanged).

It is recommended, therefore, that only `BCF`, `BSF`, `SWAPF` and `MOVWF` instructions are used to alter the STATUS register, because these instructions do not affect any STATUS bit. For other instructions not affecting any STATUS bits, see the "Instruction Set Summary".

**Note 1:** The IRP and RP1 bits (STATUS<7:6>) are not used by the PIC16C62X and should be programmed as '0'. Use of these bits as general purpose R/W bits is NOT recommended, since this may affect upward compatibility with future products.

**2:** The C and DC bits operate as a Borrow and Digit Borrow out bit, respectively, in subtraction. See the `SUBLW` and `SUBWF` instructions for examples.

### REGISTER 4-1: STATUS REGISTER (ADDRESS 03H OR 83H)

Reserved	Reserved	R/W-0	R-1	R-1	R/W-x	R/W-x	R/W-x
IRP	RP1	RP0	$\overline{\text{TO}}$	$\overline{\text{PD}}$	Z	DC	C
bit 7							bit 0

- bit 7 **IRP:** Register Bank Select bit (used for indirect addressing)  
 1 = Bank 2, 3 (100h - 1FFh)  
 0 = Bank 0, 1 (00h - FFh)  
 The IRP bit is reserved on the PIC16C62X; always maintain this bit clear.
- bit 6-5 **RP<1:0>:** Register Bank Select bits (used for direct addressing)  
 01 = Bank 1 (80h - FFh)  
 00 = Bank 0 (00h - 7Fh)  
 Each bank is 128 bytes. The RP1 bit is reserved on the PIC16C62X; always maintain this bit clear.
- bit 4  **$\overline{\text{TO}}$ :** Time-out bit  
 1 = After power-up, `CLRWDT` instruction, or `SLEEP` instruction  
 0 = A WDT time-out occurred
- bit 3  **$\overline{\text{PD}}$ :** Power-down bit  
 1 = After power-up or by the `CLRWDT` instruction  
 0 = By execution of the `SLEEP` instruction
- bit 2 **Z:** Zero bit  
 1 = The result of an arithmetic or logic operation is zero  
 0 = The result of an arithmetic or logic operation is not zero
- bit 1 **DC:** Digit carry/borrow bit (`ADDWF`, `ADDLW`, `SUBLW`, `SUBWF` instructions)(for borrow the polarity is reversed)  
 1 = A carry-out from the 4th low order bit of the result occurred  
 0 = No carry-out from the 4th low order bit of the result
- bit 0 **C:** Carry/borrow bit (`ADDWF`, `ADDLW`, `SUBLW`, `SUBWF` instructions)  
 1 = A carry-out from the Most Significant bit of the result occurred  
 0 = No carry-out from the Most Significant bit of the result occurred
- Note:** For borrow the polarity is reversed. A subtraction is executed by adding the two's complement of the second operand. For rotate (`RRF`, `RLF`) instructions, this bit is loaded with either the high or low order bit of the source register.

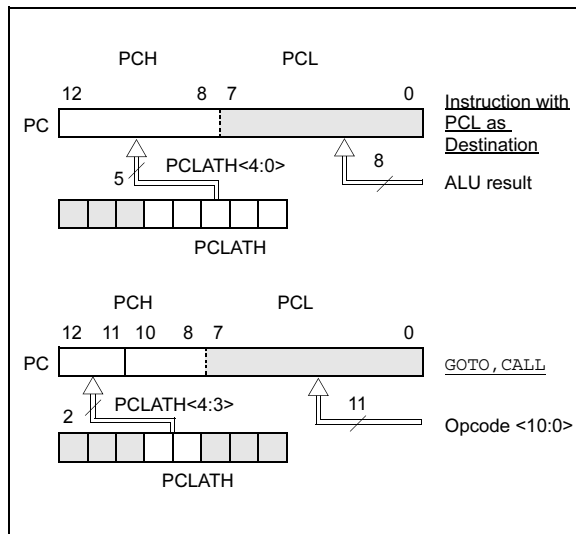
#### Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared    x = Bit is unknown

## 4.3 PCL and PCLATH

The program counter (PC) is 13-bits wide. The low byte comes from the PCL register, which is a readable and writable register. The high byte (PC<12:8>) is not directly readable or writable and comes from PCLATH. On any RESET, the PC is cleared. Figure 4-8 shows the two situations for the loading of the PC. The upper example in the figure shows how the PC is loaded on a write to PCL (PCLATH<4:0> → PCH). The lower example in the figure shows how the PC is loaded during a CALL or GOTO instruction (PCLATH<4:3> → PCH).

**FIGURE 4-8: LOADING OF PC IN DIFFERENT SITUATIONS**



### 4.3.1 COMPUTED GOTO

A computed GOTO is accomplished by adding an offset to the program counter (ADDWF PCL). When doing a table read using a computed GOTO method, care should be exercised if the table location crosses a PCL memory boundary (each 256 byte block). Refer to the application note, "Implementing a Table Read" (AN556).

### 4.3.2 STACK

The PIC16C62X family has an 8-level deep x 13-bit wide hardware stack (Figure 4-2 and Figure 4-3). The stack space is not part of either program or data space and the stack pointer is not readable or writable. The PC is PUSHed onto the stack when a CALL instruction is executed or an interrupt causes a branch. The stack is POPed in the event of a RETURN, RETLW or a RETFIE instruction execution. PCLATH is not affected by a PUSH or POP operation.

The stack operates as a circular buffer. This means that after the stack has been PUSHed eight times, the ninth push overwrites the value that was stored from the first push. The tenth push overwrites the second push (and so on).

**Note 1:** There are no STATUS bits to indicate stack overflow or stack underflow conditions.

**2:** There are no instructions/mnemonics called PUSH or POP. These are actions that occur from the execution of the CALL, RETURN, RETLW and RETFIE instructions, or the vectoring to an interrupt address.

## 5.3 I/O Programming Considerations

### 5.3.1 BI-DIRECTIONAL I/O PORTS

Any instruction which writes, operates internally as a read followed by a write operation. The `BCF` and `BSF` instructions, for example, read the register into the CPU, execute the bit operation and write the result back to the register. Caution must be used when these instructions are applied to a port with both inputs and outputs defined. For example, a `BSF` operation on bit5 of `PORTB` will cause all eight bits of `PORTB` to be read into the CPU. Then the `BSF` operation takes place on bit5 and `PORTB` is written to the output latches. If another bit of `PORTB` is used as a bi-directional I/O pin (e.g., bit0) and it is defined as an input at this time, the input signal present on the pin itself would be read into the CPU and re-written to the data latch of this particular pin, overwriting the previous content. As long as the pin stays in the Input mode, no problem occurs. However, if bit0 is switched into Output mode later on, the content of the data latch may now be unknown.

Reading the port register reads the values of the port pins. Writing to the port register writes the value to the port latch. When using read-modify-write instructions (ex. `BCF`, `BSF`, etc.) on a port, the value of the port pins is read, the desired operation is done to this value, and this value is then written to the port latch.

Example 5-2 shows the effect of two sequential read-modify-write instructions (ex., `BCF`, `BSF`, etc.) on an I/O port.

A pin actively outputting a Low or High should not be driven from external devices at the same time in order to change the level on this pin ("wired-or", "wired-and"). The resulting high output currents may damage the chip.

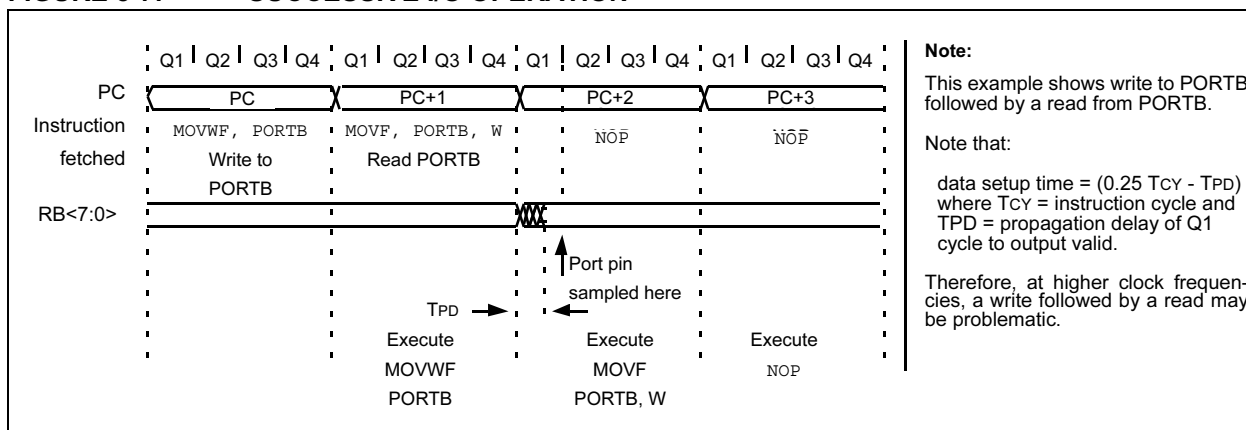
### EXAMPLE 5-2: READ-MODIFY-WRITE INSTRUCTIONS ON AN I/O PORT

```
; Initial PORT settings:   PORTB<7:4> Inputs
;
;                           PORTB<3:0> Outputs
; PORTB<7:6> have external pull-up and are not
; connected to other circuitry
;
;                           PORT latch  PORT pins
;                           -----  -
;
; BCF PORTB, 7             ; 01pp pppp   11pp pppp
; BCF PORTB, 6             ; 10pp pppp   11pp pppp
; BSF STATUS,RP0           ;
; BCF TRISB, 7             ; 10pp pppp   11pp pppp
; BCF TRISB, 6             ; 10pp pppp   10pp pppp
;
; Note that the user may have expected the pin
; values to be 00pp pppp. The 2nd BCF caused
; RB7 to be latched as the pin value (High).
```

### 5.3.2 SUCCESSIVE OPERATIONS ON I/O PORTS

The actual write to an I/O port happens at the end of an instruction cycle, whereas for reading, the data must be valid at the beginning of the instruction cycle (Figure 5-7). Therefore, care must be exercised if a write followed by a read operation is carried out on the same I/O port. The sequence of instructions should be such to allow the pin voltage to stabilize (load dependent) before the next instruction which causes that file to be read into the CPU is executed. Otherwise, the previous state of that pin may be read into the CPU rather than the new state. When in doubt, it is better to separate these instructions with a `NOP` or another instruction not accessing this I/O port.

FIGURE 5-7: SUCCESSIVE I/O OPERATION



# PIC16C62X

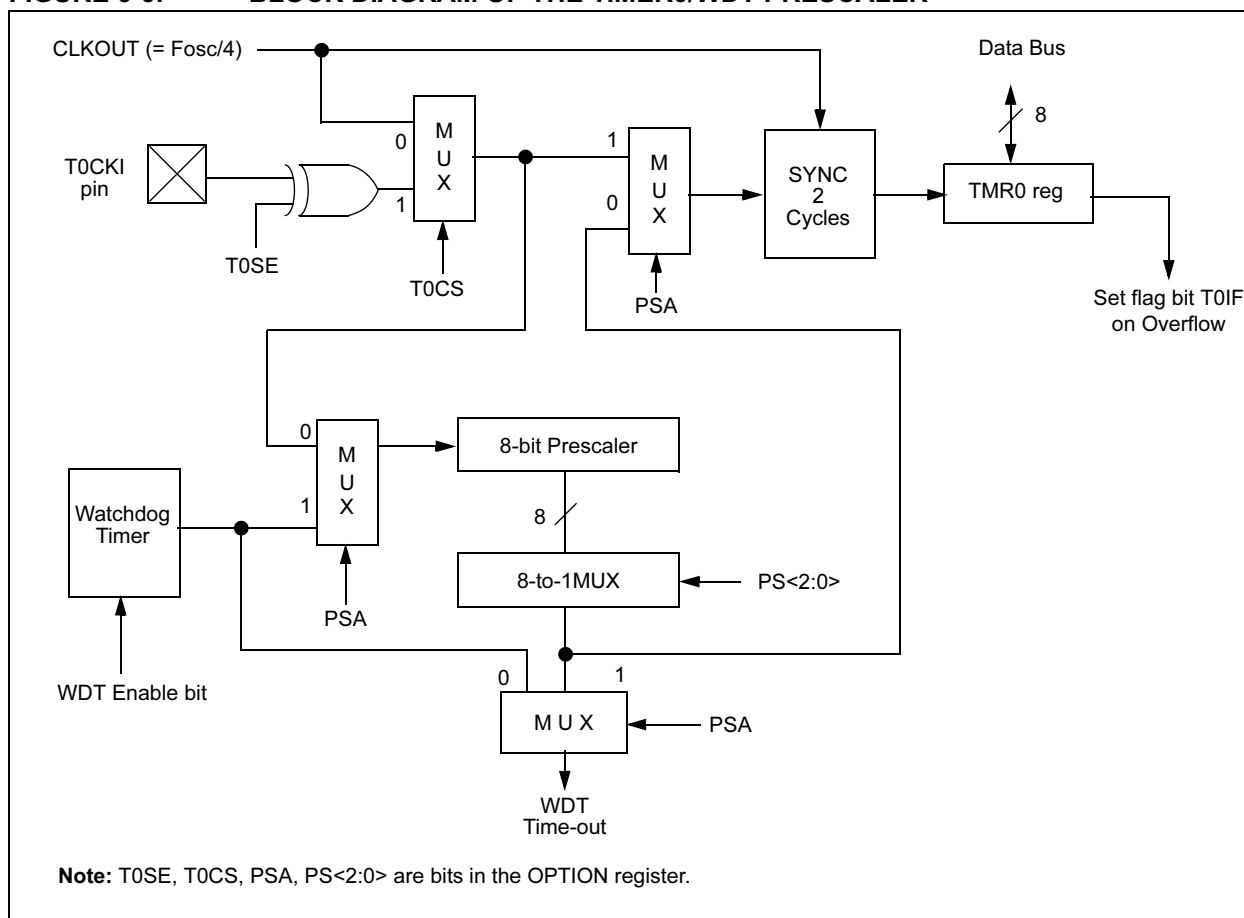
## 6.3 Prescaler

An 8-bit counter is available as a prescaler for the Timer0 module, or as a postscale for the Watchdog Timer, respectively (Figure 6-6). For simplicity, this counter is being referred to as “prescaler” throughout this data sheet. Note that there is only one prescaler available which is mutually exclusive between the Timer0 module and the Watchdog Timer. Thus, a prescaler assignment for the Timer0 module means that there is no prescaler for the Watchdog Timer and vice-versa.

The PSA and PS<2:0> bits (OPTION<3:0>) determine the prescaler assignment and prescale ratio.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g., `CLRF 1`, `MOVWF 1`, `BSF 1,x....etc.`) will clear the prescaler. When assigned to WDT, a `CLRWDT` instruction will clear the prescaler along with the Watchdog Timer. The prescaler is not readable or writable.

**FIGURE 6-6: BLOCK DIAGRAM OF THE TIMER0/WDT PRESCALER**



## 6.3.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control (i.e., it can be changed “on-the-fly” during program execution). To avoid an unintended device RESET, the following instruction sequence (Example 6-1) must be executed when changing the prescaler assignment from Timer0 to WDT.)

### EXAMPLE 6-1: CHANGING PRESCALER (TIMER0→WDT)

```

1.BCF      STATUS, RP0    ;Skip if already in
                           ;Bank 0
2.CLRWDT                      ;Clear WDT
3.CLRF      TMR0          ;Clear TMR0 & Prescaler
4.BSF      STATUS, RP0    ;Bank 1
5.MOVLW     '00101111'b;  ;These 3 lines (5, 6, 7)
6.MOVWF     OPTION        ;are required only if
                           ;desired PS<2:0> are
7.CLRWDT                      ;000 or 001
8.MOVLW     '00101xxx'b   ;Set Postscaler to
9.MOVWF     OPTION        ;desired WDT rate
10.BCF      STATUS, RP0    ;Return to Bank 0
    
```

To change prescaler from the WDT to the TMR0 module, use the sequence shown in Example 6-2. This precaution must be taken even if the WDT is disabled.

### EXAMPLE 6-2: CHANGING PRESCALER (WDT→TIMER0)

```

CLRWDT                      ;Clear WDT and
                           ;prescaler
BSF      STATUS, RP0
MOVLW     b'xxxx0xxx'      ;Select TMR0, new
                           ;prescale value and
                           ;clock source
MOVWF     OPTION_REG
BCF      STATUS, RP0
    
```

TABLE 6-1: REGISTERS ASSOCIATED WITH TIMER0

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on All Other RESETS
01h	TMR0	Timer0 module register								xxxx xxxx	uuuu uuuu
0Bh/8Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
81h	OPTION	RBPU	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
85h	TRISA	—	—	—	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	---1 1111	---1 1111

Legend: — = Unimplemented locations, read as '0', u = unchanged, x = unknown

**Note:** Shaded bits are not used by TMR0 module.

# PIC16C62X

## 9.1 Configuration Bits

The configuration bits can be programmed (read as '0') or left unprogrammed (read as '1') to select various device configurations. These bits are mapped in program memory location 2007h.

The user will note that address 2007h is beyond the user program memory space. In fact, it belongs to the special test/configuration memory space (2000h – 3FFFh), which can be accessed only during programming.

### REGISTER 9-1: CONFIGURATION WORD (ADDRESS 2007h)

CP1	CP0 (2)	CP1	$\overline{\text{CP0}}^{(2)}$	$\overline{\text{CP1}}$	CP0 (2)		BODEN	CP1	CP0 (2)	$\overline{\text{PWRT}}^{\text{E}}$	WDTE	F0SC1	F0SC0
bit 13													bit 0

bit 13-8, 5-4: **CP<1:0>**: Code protection bit pairs (2)  
 Code protection for 2K program memory  
 11 = Program memory code protection off  
 10 = 0400h-07FFh code protected  
 01 = 0200h-07FFh code protected  
 00 = 0000h-07FFh code protected

Code protection for 1K program memory  
 11 = Program memory code protection off  
 10 = Program memory code protection off  
 01 = 0200h-03FFh code protected  
 00 = 0000h-03FFh code protected

Code protection for 0.5K program memory  
 11 = Program memory code protection off  
 10 = Program memory code protection off  
 01 = Program memory code protection off  
 00 = 0000h-01FFh code protected

bit 7: **Unimplemented**: Read as '0'

bit 6: **BODEN**: Brown-out Reset Enable bit (1)  
 1 = BOR enabled  
 0 = BOR disabled

bit 3: **PWRT<sup>E</sup>**: Power-up Timer Enable bit (1, 3)  
 1 = PWRT disabled  
 0 = PWRT enabled

bit 2: **WDTE**: Watchdog Timer Enable bit  
 1 = WDT enabled  
 0 = WDT disabled

bit 1-0: **FOSC1:FOSC0**: Oscillator Selection bits  
 11 = RC oscillator  
 10 = HS oscillator  
 01 = XT oscillator  
 00 = LP oscillator

- Note 1:** Enabling Brown-out Reset automatically enables Power-up Timer (PWRT) regardless of the value of bit  $\overline{\text{PWRT}}^{\text{E}}$ . Ensure the Power-up Timer is enabled anytime Brown-out Detect Reset is enabled.
- 2:** All of the CP<1:0> pairs have to be given the same value to enable the code protection scheme listed.
- 3:** Unprogrammed parts default the Power-up Timer disabled.

#### Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	1 = bit is set	0 = bit is cleared      x = bit is unknown



## 9.3 RESET

The PIC16C62X differentiates between various kinds of RESET:

- Power-on Reset (POR)
- $\overline{\text{MCLR}}$  Reset during normal operation
- $\overline{\text{MCLR}}$  Reset during SLEEP
- WDT Reset (normal operation)
- WDT wake-up (SLEEP)
- Brown-out Reset (BOR)

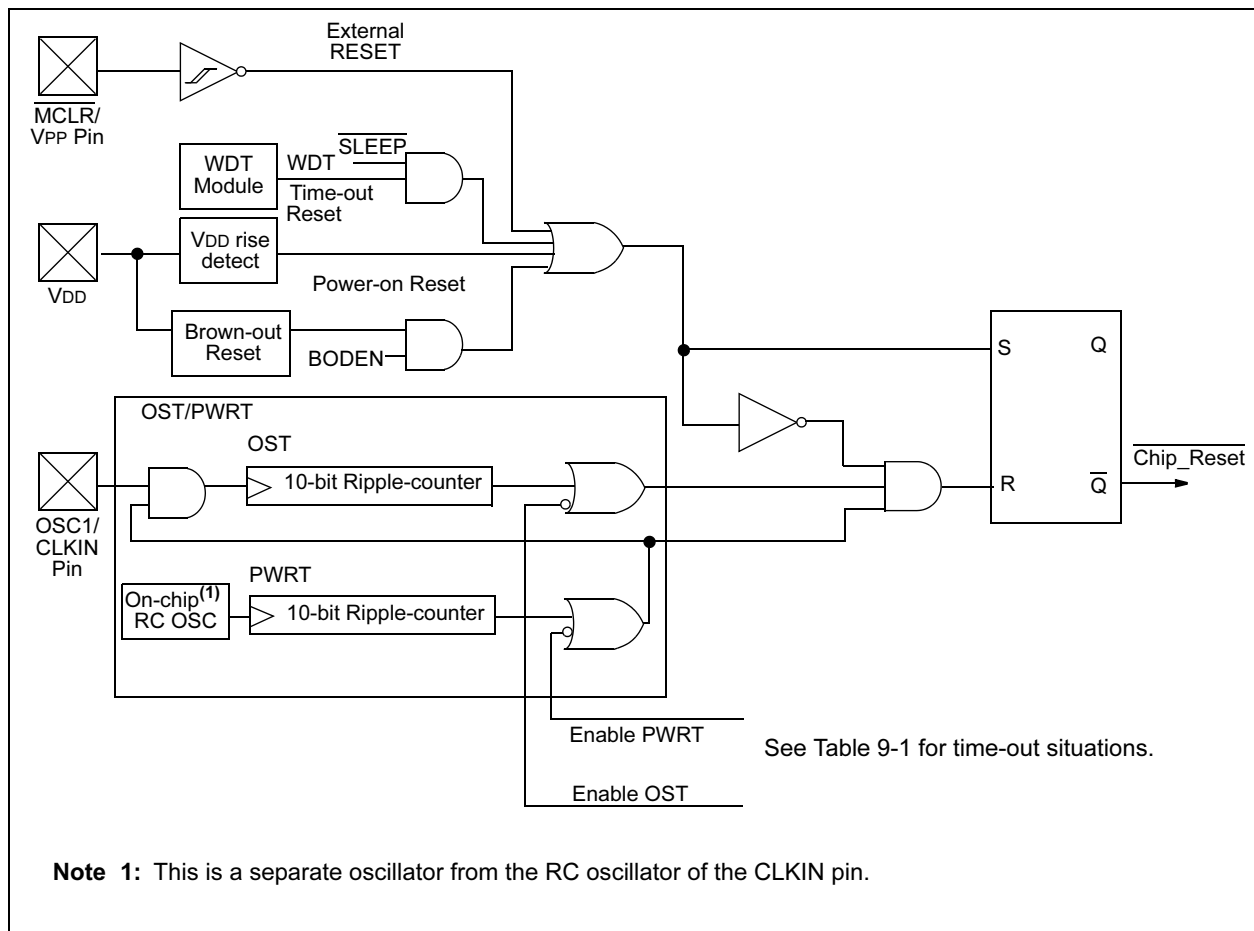
Some registers are not affected in any RESET condition. Their status is unknown on POR and unchanged in any other RESET. Most other registers are reset to a "RESET state" on Power-on Reset,

$\overline{\text{MCLR}}$  Reset, WDT Reset and  $\overline{\text{MCLR}}$  Reset during SLEEP. They are not affected by a WDT wake-up, since this is viewed as the resumption of normal operation.  $\overline{\text{TO}}$  and  $\overline{\text{PD}}$  bits are set or cleared differently in different RESET situations as indicated in Table 9-2. These bits are used in software to determine the nature of the RESET. See Table 9-5 for a full description of RESET states of all registers.

A simplified block diagram of the on-chip RESET circuit is shown in Figure 9-6.

The  $\overline{\text{MCLR}}$  Reset path has a noise filter to detect and ignore small pulses. See Table 12-5 for pulse width specification.

**FIGURE 9-6: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT**



# PIC16C62X

## 9.4 Power-on Reset (POR), Power-up Timer (PWRT), Oscillator Start-up Timer (OST) and Brown-out Reset (BOR)

### 9.4.1 POWER-ON RESET (POR)

The on-chip POR circuit holds the chip in RESET until VDD has reached a high enough level for proper operation. To take advantage of the POR, just tie the MCLR pin through a resistor to VDD. This will eliminate external RC components usually needed to create Power-on Reset. A maximum rise time for VDD is required. See Electrical Specifications for details.

The POR circuit does not produce an internal RESET when VDD declines.

When the device starts normal operation (exits the RESET condition), device operating parameters (voltage, frequency, temperature, etc.) must be met to ensure operation. If these conditions are not met, the device must be held in RESET until the operating conditions are met.

For additional information, refer to Application Note AN607, "Power-up Trouble Shooting".

### 9.4.2 POWER-UP TIMER (PWRT)

The Power-up Timer provides a fixed 72 ms (nominal) time-out on power-up only, from POR or Brown-out Reset. The Power-up Timer operates on an internal RC oscillator. The chip is kept in RESET as long as PWRT is active. The PWRT delay allows the VDD to rise to an acceptable level. A configuration bit, `PWRT`, can disable (if set) or enable (if cleared or programmed) the Power-up Timer. The Power-up Timer should always be enabled when Brown-out Reset is enabled.

The Power-up Time delay will vary from chip-to-chip and due to VDD, temperature and process variation. See DC parameters for details.

### 9.4.3 OSCILLATOR START-UP TIMER (OST)

The Oscillator Start-Up Timer (OST) provides a 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over. This ensures that the crystal oscillator or resonator has started and stabilized.

The OST time-out is invoked only for XT, LP and HS modes and only on Power-on Reset or wake-up from SLEEP.

### 9.4.4 BROWN-OUT RESET (BOR)

The PIC16C62X members have on-chip Brown-out Reset circuitry. A configuration bit, `BODEN`, can disable (if clear/programmed) or enable (if set) the Brown-out Reset circuitry. If VDD falls below 4.0V refer to VBOR parameter D005 (VBOR) for greater than parameter (TBOR) in Table 12-5. The brown-out situation will RESET the chip. A RESET won't occur if VDD falls below 4.0V for less than parameter (TBOR).

On any RESET (Power-on, Brown-out, Watchdog, etc.) the chip will remain in RESET until VDD rises above BVDD. The Power-up Timer will now be invoked and will keep the chip in RESET an additional 72 ms.

If VDD drops below BVDD while the Power-up Timer is running, the chip will go back into a Brown-out Reset and the Power-up Timer will be re-initialized. Once VDD rises above BVDD, the Power-Up Timer will execute a 72 ms RESET. The Power-up Timer should always be enabled when Brown-out Reset is enabled. Figure 9-7 shows typical Brown-out situations.

**FIGURE 9-7: BROWN-OUT SITUATIONS**

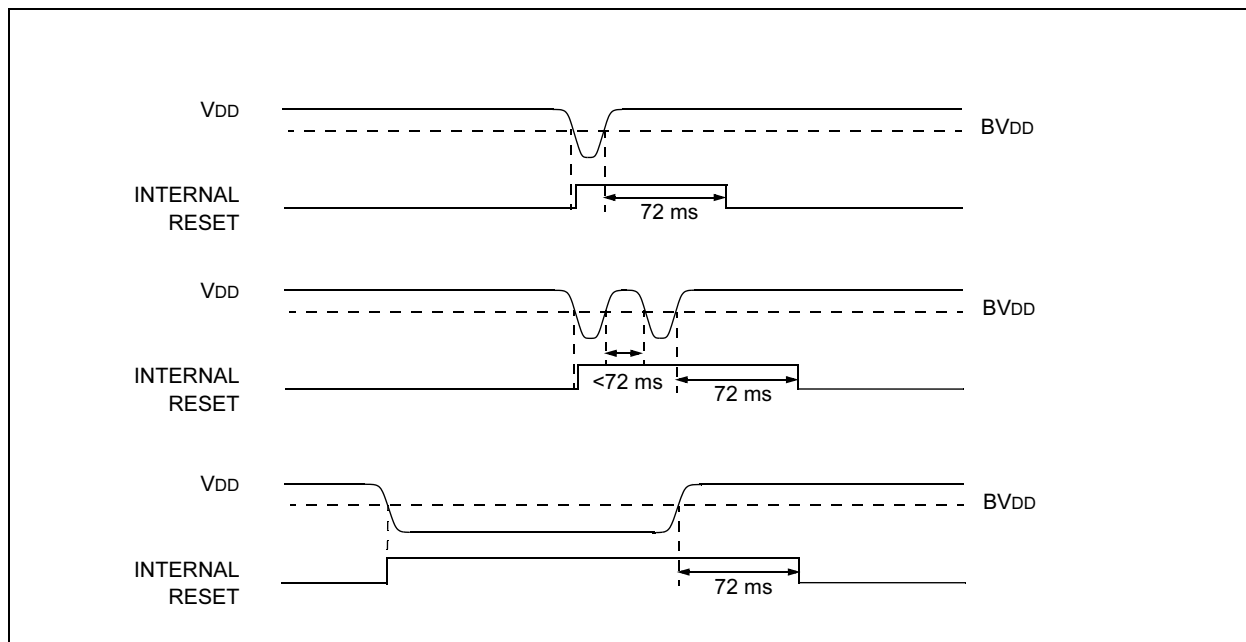


FIGURE 9-8: TIME-OUT SEQUENCE ON POWER-UP ( $\overline{\text{MCLR}}$  NOT TIED TO  $V_{DD}$ ): CASE 1

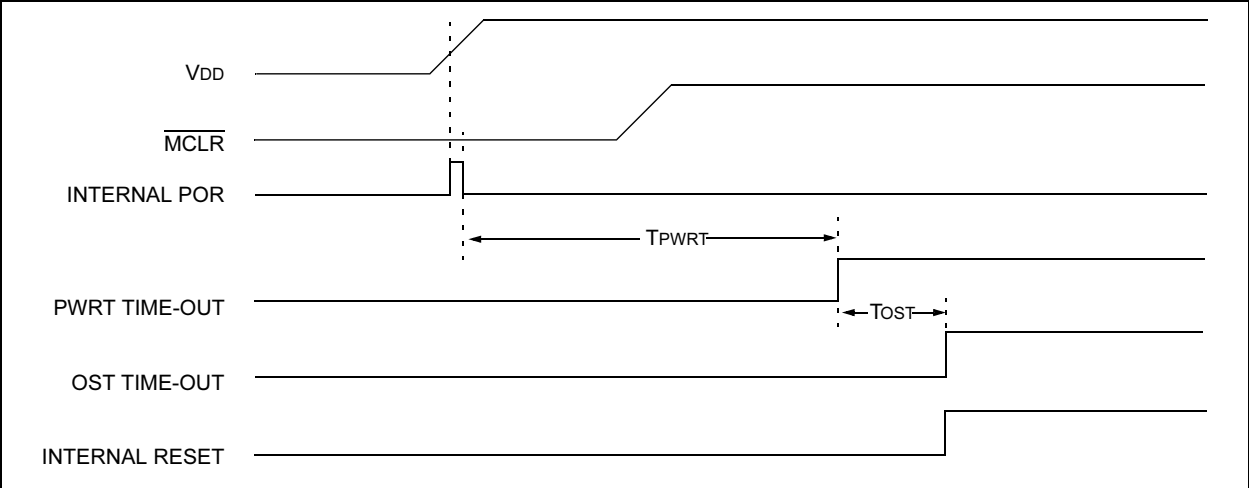


FIGURE 9-9: TIME-OUT SEQUENCE ON POWER-UP ( $\overline{\text{MCLR}}$  NOT TIED TO  $V_{DD}$ ): CASE 2

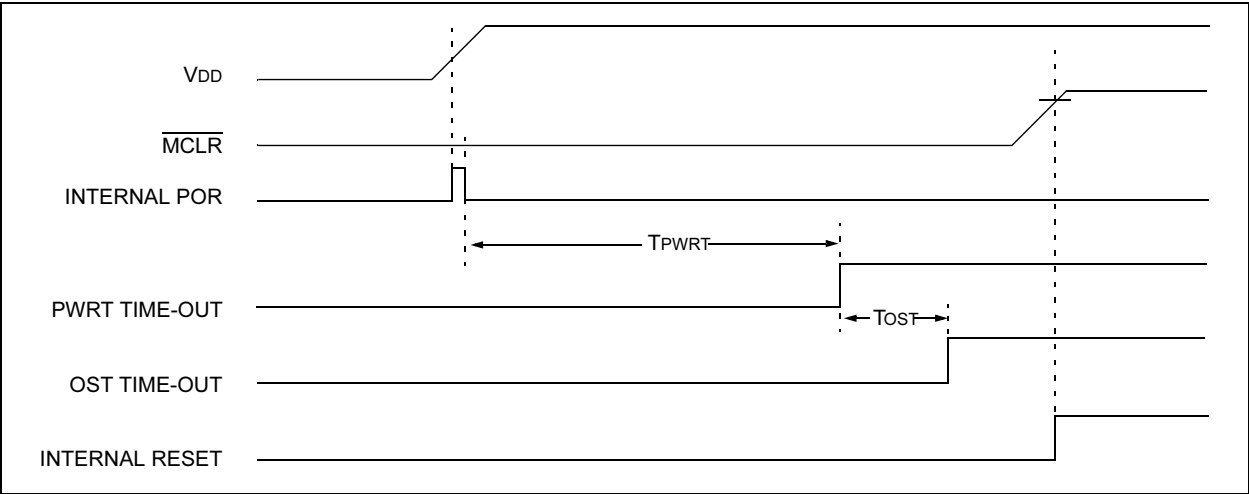
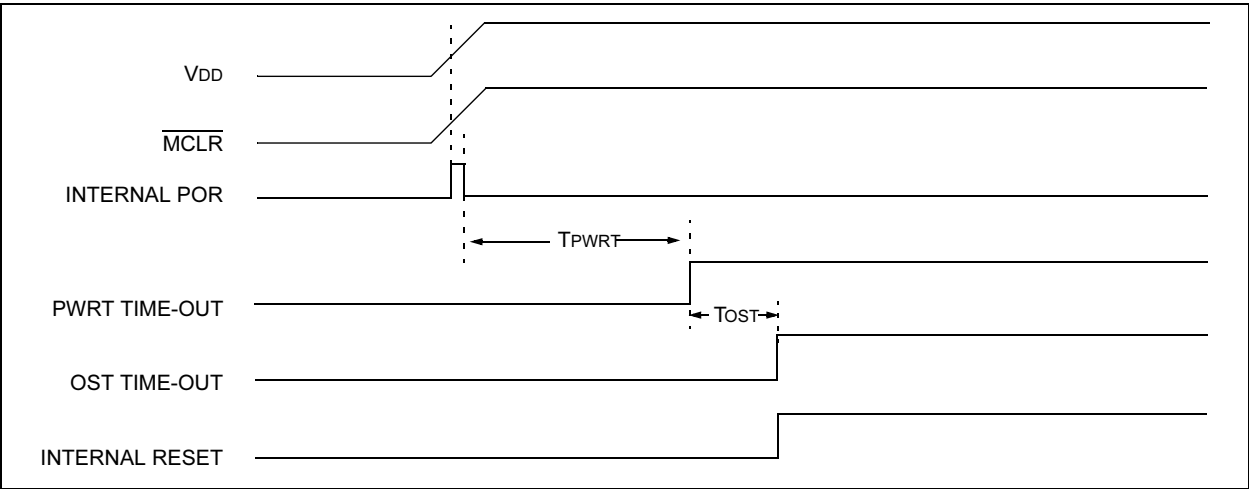


FIGURE 9-10: TIME-OUT SEQUENCE ON POWER-UP ( $\overline{\text{MCLR}}$  TIED TO  $V_{DD}$ )



## 9.8 Power-Down Mode (SLEEP)

The Power-down mode is entered by executing a SLEEP instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the PD bit in the STATUS register is cleared, the TO bit is set, and the oscillator driver is turned off. The I/O ports maintain the status they had, before SLEEP was executed (driving high, low, or hi-impedance).

For lowest current consumption in this mode, all I/O pins should be either at VDD or VSS with no external circuitry drawing current from the I/O pin and the comparators and VREF should be disabled. I/O pins that are hi-impedance inputs should be pulled high or low externally to avoid switching currents caused by floating inputs. The T0CKI input should also be at VDD or VSS for lowest current consumption. The contribution from on chip pull-ups on PORTB should be considered.

The MCLR pin must be at a logic high level (VIHMC).

**Note:** It should be noted that a RESET generated by a WDT time-out does not drive MCLR pin low.

The first event will cause a device RESET. The two latter events are considered a continuation of program execution. The  $\overline{TO}$  and  $\overline{PD}$  bits in the STATUS register can be used to determine the cause of device RESET. PD bit, which is set on power-up, is cleared when SLEEP is invoked.  $\overline{TO}$  bit is cleared if WDT wake-up occurred.

When the SLEEP instruction is being executed, the next instruction (PC + 1) is pre-fetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the GIE bit. If the GIE bit is clear (disabled), the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is set (enabled), the device executes the instruction after the SLEEP instruction and then branches to the interrupt address (0004h). In cases where the execution of the instruction following SLEEP is not desirable, the user should have an NOP after the SLEEP instruction.

**Note:** If the global interrupts are disabled (GIE is cleared), but any interrupt source has both its interrupt enable bit and the corresponding interrupt flag bits set, the device will immediately wake-up from SLEEP. The SLEEP instruction is completely executed.

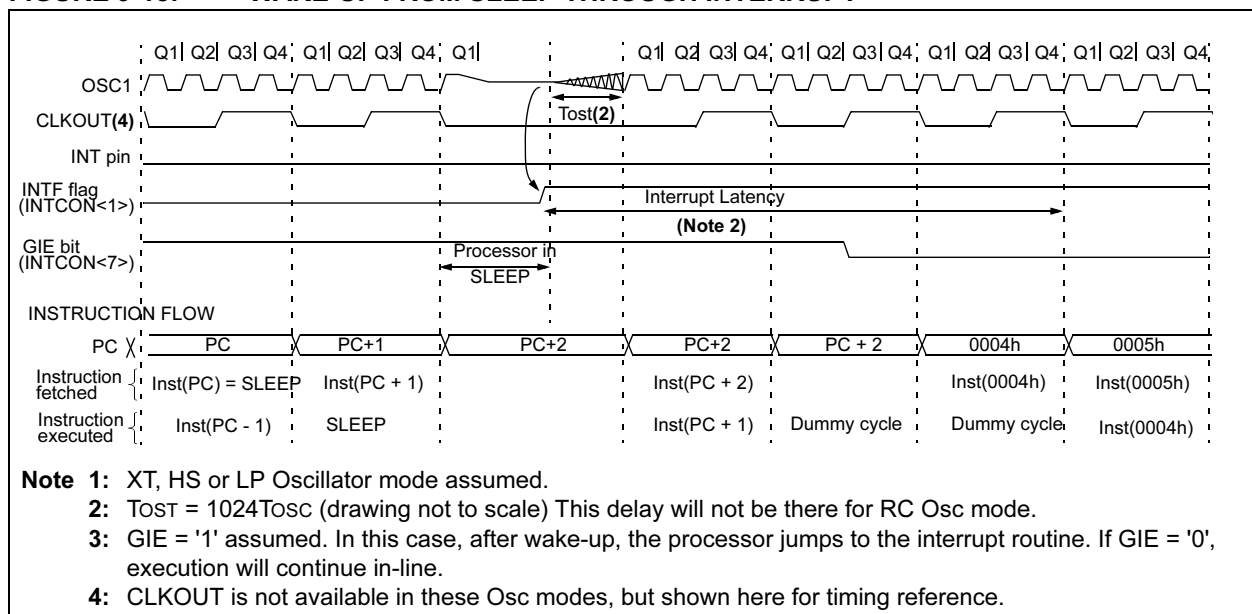
### 9.8.1 WAKE-UP FROM SLEEP

The device can wake-up from SLEEP through one of the following events:

1. External RESET input on MCLR pin
2. Watchdog Timer Wake-up (if WDT was enabled)
3. Interrupt from RB0/INT pin, RB Port change, or the Peripheral Interrupt (Comparator).

The WDT is cleared when the device wakes up from SLEEP, regardless of the source of wake-up.

**FIGURE 9-18: WAKE-UP FROM SLEEP THROUGH INTERRUPT**



## DECFSZ      Decrement f, Skip if 0

**Syntax:**      `[label] DECFSZ f,d`

**Operands:**       $0 \leq f \leq 127$   
 $d \in [0,1]$

**Operation:**       $(f) - 1 \rightarrow (\text{dest}); \quad \text{skip if result} = 0$

**Status Affected:**      None

**Encoding:**

00	1011	dfff	ffff
----	------	------	------

**Description:**      The contents of register 'f' are decremented. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'.  
 If the result is 0, the next instruction, which is already fetched, is discarded. A NOP is executed instead making it a two-cycle instruction.

**Words:**      1

**Cycles:**      1(2)

**Example**

```

    HERE      DECFSZ  CNT, 1
              GOTO    LOOP
    CONTINUE  •
              •
              •
    
```

**Before Instruction**  
 PC = address HERE

**After Instruction**  
 CNT = CNT - 1  
 if CNT = 0,  
 PC = address CONTINUE  
 if CNT  $\neq$  0,  
 PC = address HERE+1

## GOTO      Unconditional Branch

**Syntax:**      `[label] GOTO k`

**Operands:**       $0 \leq k \leq 2047$

**Operation:**       $k \rightarrow \text{PC}<10:0>$   
 $\text{PCLATH}<4:3> \rightarrow \text{PC}<12:11>$

**Status Affected:**      None

**Encoding:**

10	1kkk	kkkk	kkkk
----	------	------	------

**Description:**      GOTO is an unconditional branch. The eleven bit immediate value is loaded into PC bits <10:0>. The upper bits of PC are loaded from PCLATH<4:3>. GOTO is a two-cycle instruction.

**Words:**      1

**Cycles:**      2

**Example**

```

    GOTO THERE
    
```

**After Instruction**  
 PC = Address THERE

## INCF      Increment f

**Syntax:**      `[label] INCF f,d`

**Operands:**       $0 \leq f \leq 127$   
 $d \in [0,1]$

**Operation:**       $(f) + 1 \rightarrow (\text{dest})$

**Status Affected:**      Z

**Encoding:**

00	1010	dfff	ffff
----	------	------	------

**Description:**      The contents of register 'f' are incremented. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'.

**Words:**      1

**Cycles:**      1

**Example**

```

    INCF  CNT, 1
    
```

**Before Instruction**  
 CNT = 0xFF  
 Z = 0

**After Instruction**  
 CNT = 0x00  
 Z = 1

## RLF Rotate Left f through Carry

**Syntax:** [ *label* ] RLF f,d

**Operands:**  $0 \leq f \leq 127$   
 $d \in [0,1]$

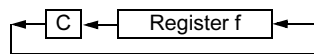
**Operation:** See description below

**Status Affected:** C

**Encoding:**

00	1101	dfff	ffff
----	------	------	------

**Description:** The contents of register 'f' are rotated one bit to the left through the Carry Flag. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is stored back in register 'f'.



**Words:** 1

**Cycles:** 1

**Example** RLF REG1,0

**Before Instruction**

REG1 = 1110 0110  
 C = 0

**After Instruction**

REG1 = 1110 0110  
 W = 1100 1100  
 C = 1

## RRF Rotate Right f through Carry

**Syntax:** [ *label* ] RRF f,d

**Operands:**  $0 \leq f \leq 127$   
 $d \in [0,1]$

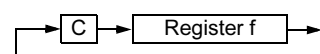
**Operation:** See description below

**Status Affected:** C

**Encoding:**

00	1100	dfff	ffff
----	------	------	------

**Description:** The contents of register 'f' are rotated one bit to the right through the Carry Flag. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'.



**Words:** 1

**Cycles:** 1

**Example** RRF REG1,0

**Before Instruction**

REG1 = 1110 0110  
 C = 0

**After Instruction**

REG1 = 1110 0110  
 W = 0111 0011  
 C = 0

## SLEEP

**Syntax:** [ *label* ] SLEEP ]

**Operands:** None

**Operation:** 00h → WDT,  
 0 → WDT prescaler,  
 1 →  $\overline{TO}$ ,  
 0 → PD

**Status Affected:**  $\overline{TO}$ , PD

**Encoding:**

00	0000	0110	0011
----	------	------	------

**Description:** The power-down STATUS bit, PD is cleared. Time-out STATUS bit,  $\overline{TO}$  is set. Watch-dog Timer and its prescaler are cleared.

The processor is put into SLEEP mode with the oscillator stopped. See Section 9.8 for more details.

**Words:** 1

**Cycles:** 1

**Example:** SLEEP

# PIC16C62X

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NOTES:

## 12.0 ELECTRICAL SPECIFICATIONS

### Absolute Maximum Ratings †

Ambient Temperature under bias .....	-40° to +125°C
Storage Temperature .....	-65° to +150°C
Voltage on any pin with respect to VSS (except VDD and $\overline{\text{MCLR}}$ ) .....	-0.6V to VDD +0.6V
Voltage on VDD with respect to VSS .....	0 to +7.5V
Voltage on $\overline{\text{MCLR}}$ with respect to VSS ( <b>Note 2</b> ) .....	0 to +14V
Voltage on RA4 with respect to VSS .....	8.5V
Total power Dissipation ( <b>Note 1</b> ) .....	1.0W
Maximum Current out of VSS pin .....	300 mA
Maximum Current into VDD pin .....	250 mA
Input Clamp Current, I <sub>IK</sub> (V <sub>I</sub> < 0 or V <sub>I</sub> > VDD) .....	±20 mA
Output Clamp Current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > VDD) .....	±20 mA
Maximum Output Current sunk by any I/O pin .....	25 mA
Maximum Output Current sourced by any I/O pin .....	25 mA
Maximum Current sunk by PORTA and PORTB .....	200 mA
Maximum Current sourced by PORTA and PORTB .....	200 mA

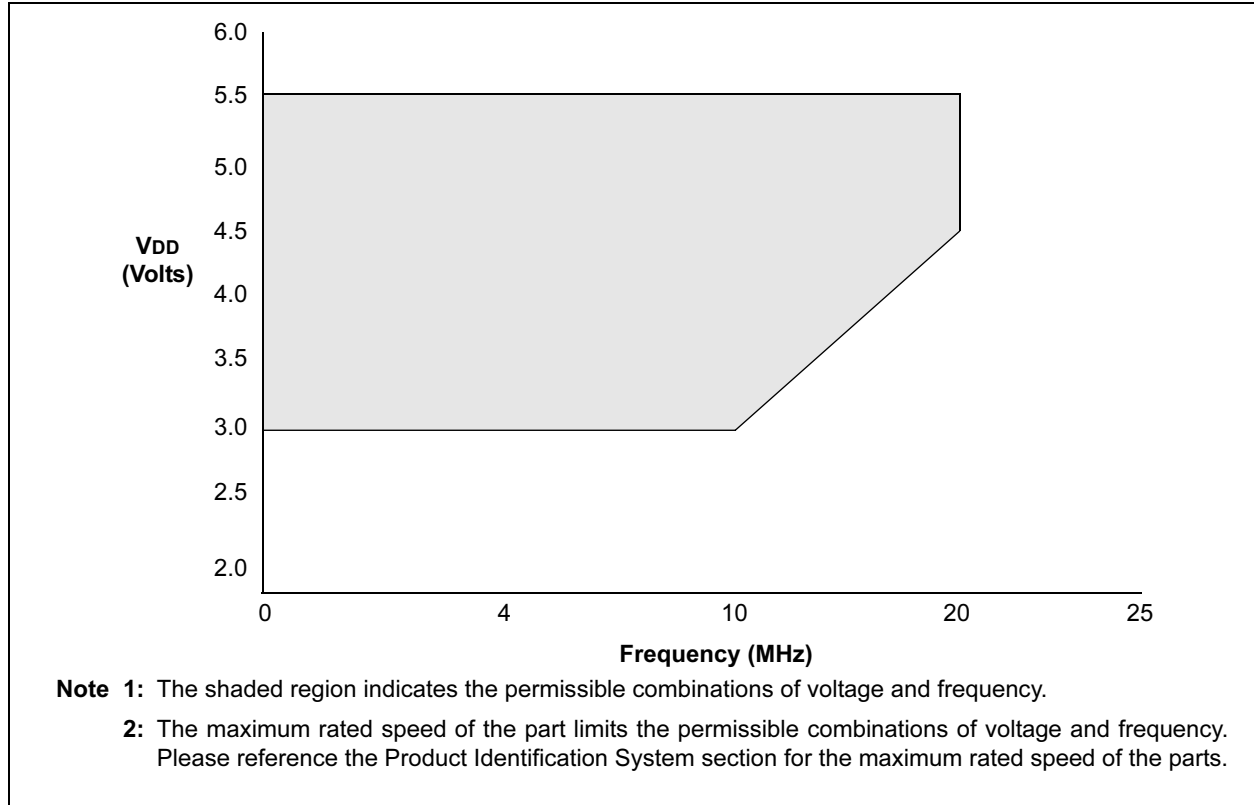
**Note 1:** Power dissipation is calculated as follows:  $P_{DIS} = V_{DD} \times \{I_{DD} - \sum I_{OH}\} + \sum \{(V_{DD} - V_{OH}) \times I_{OH}\} + \sum (V_{OL} \times I_{OL})$ .

**2:** Voltage spikes below VSS at the  $\overline{\text{MCLR}}$  pin, inducing currents greater than 80 mA, may cause latchup. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the  $\overline{\text{MCLR}}$  pin rather than pulling this pin directly to VSS.

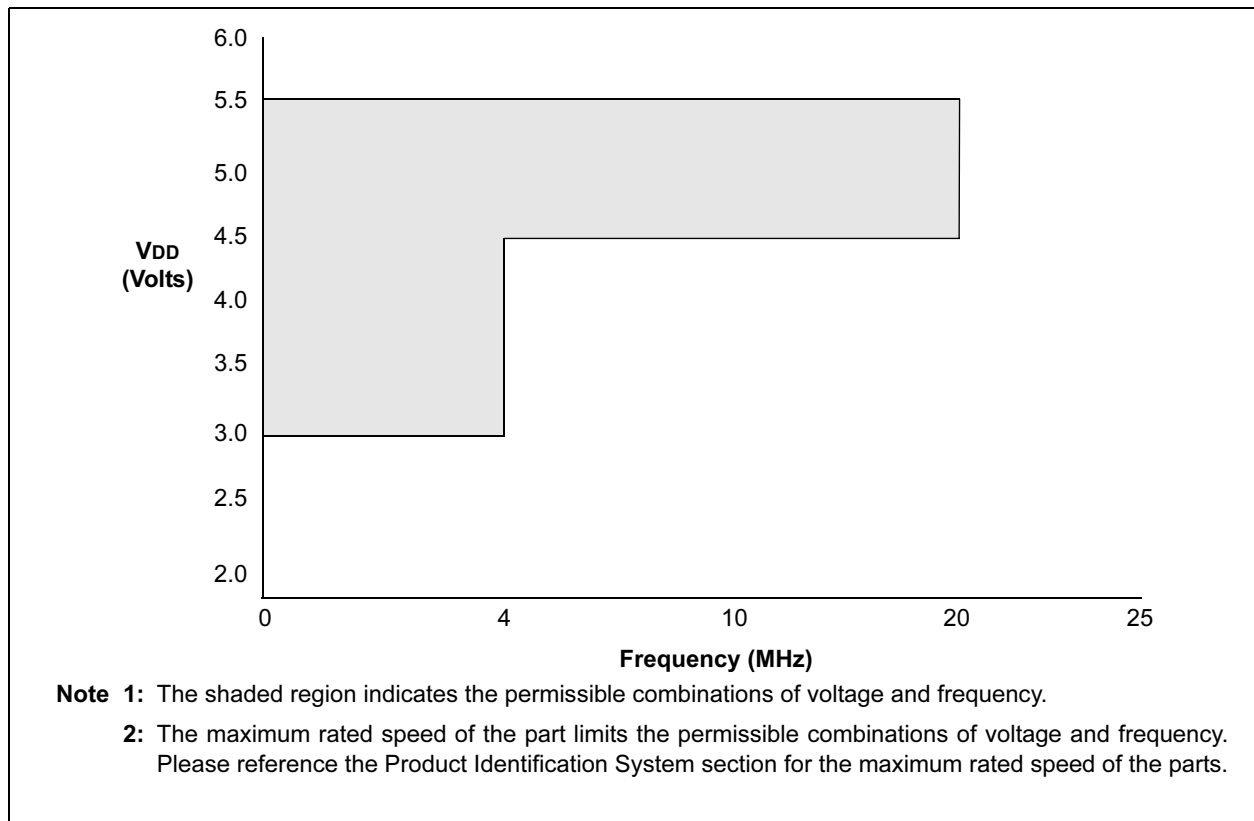
† **NOTICE:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.



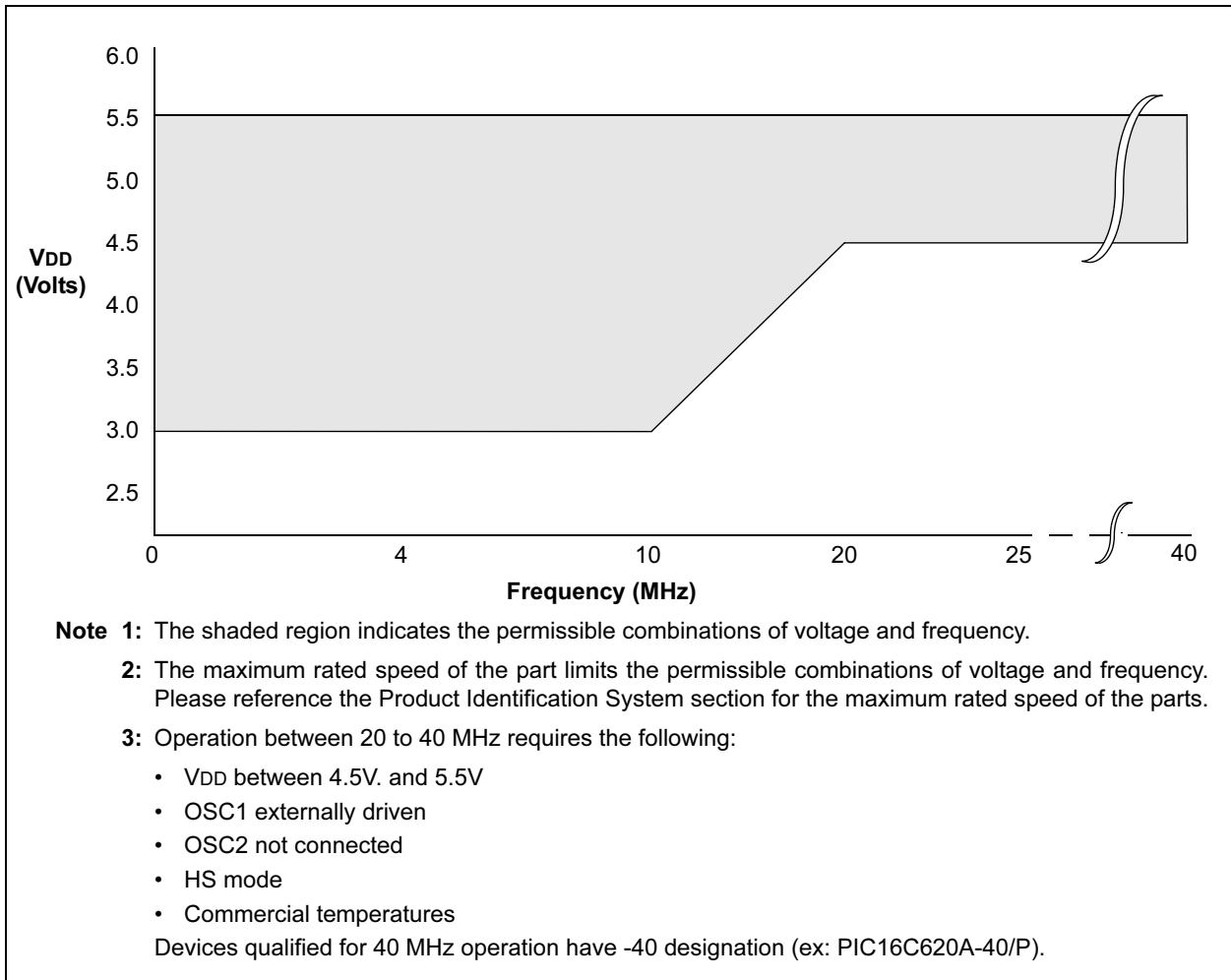
**FIGURE 12-3: PIC16C62XA VOLTAGE-FREQUENCY GRAPH,  $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$**



**FIGURE 12-4: PIC16C62XA VOLTAGE-FREQUENCY GRAPH,  $-40^{\circ}\text{C} \leq T_A \leq 0^{\circ}\text{C}$ ,  $+70^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$**



**FIGURE 12-10: PIC16C620A/C621A/C622A/CR620A - 40 VOLTAGE-FREQUENCY GRAPH,  $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$**



# PIC16C62X

## 12.4 DC Characteristics: PIC16C62X/C62XA/CR62XA (Commercial, Industrial, Extended) PIC16LC62X/LC62XA/LCR62XA (Commercial, Industrial, Extended)

PIC16C62X/C62XA/CR62XA			Standard Operating Conditions (unless otherwise stated)				
			Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial and $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended				
PIC16LC62X/LC62XA/LCR62XA			Standard Operating Conditions (unless otherwise stated)				
			Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial and $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended				
Param. No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
D030 D031 D032 D033	V <sub>IL</sub>	<b>Input Low Voltage</b>					
		I/O ports					
		with TTL buffer	V <sub>SS</sub>	—	0.8V 0.15 V <sub>DD</sub>	V	V <sub>DD</sub> = 4.5V to 5.5V otherwise
		with Schmitt Trigger input	V <sub>SS</sub>	—	0.2 V <sub>DD</sub>	V	
		$\overline{\text{MCLR}}$ , RA4/T0CKI, OSC1 (in RC mode)	V <sub>SS</sub>	—	0.2 V <sub>DD</sub>	V	(Note 1)
D033		OSC1 (in XT and HS)	V <sub>SS</sub>	—	0.3 V <sub>DD</sub>	V	
		OSC1 (in LP)	V <sub>SS</sub>	—	0.6 V <sub>DD</sub> - 1.0	V	
D030 D031 D032 D033	V <sub>IL</sub>	<b>Input Low Voltage</b>					
		I/O ports					
		with TTL buffer	V <sub>SS</sub>	—	0.8V 0.15 V <sub>DD</sub>	V	V <sub>DD</sub> = 4.5V to 5.5V otherwise
		with Schmitt Trigger input	V <sub>SS</sub>	—	0.2 V <sub>DD</sub>	V	
		$\overline{\text{MCLR}}$ , RA4/T0CKI, OSC1 (in RC mode)	V <sub>SS</sub>	—	0.2 V <sub>DD</sub>	V	(Note 1)
D033		OSC1 (in XT and HS)	V <sub>SS</sub>	—	0.3 V <sub>DD</sub>	V	
		OSC1 (in LP)	V <sub>SS</sub>	—	0.6 V <sub>DD</sub> - 1.0	V	
D040 D041 D042 D043 D043A	V <sub>IH</sub>	<b>Input High Voltage</b>					
		I/O ports					
		with TTL buffer	2.0V 0.25 V <sub>DD</sub> + 0.8V	—	V <sub>DD</sub> V <sub>DD</sub>	V	V <sub>DD</sub> = 4.5V to 5.5V otherwise
		with Schmitt Trigger input	0.8 V <sub>DD</sub>	—	V <sub>DD</sub>	V	
		$\overline{\text{MCLR}}$ RA4/T0CKI	0.8 V <sub>DD</sub>	—	V <sub>DD</sub>	V	
D043 D043A		OSC1 (XT, HS and LP)	0.7 V <sub>DD</sub>	—	V <sub>DD</sub>	V	
		OSC1 (in RC mode)	0.9 V <sub>DD</sub>	—	V <sub>DD</sub>	V	(Note 1)

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- Note 1:** In RC oscillator configuration, the OSC1 pin is a Schmitt Trigger input. It is not recommended that the PIC16C62X(A) be driven with external clock in RC mode.
- 2:** The leakage current on the  $\overline{\text{MCLR}}$  pin is strongly dependent on applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
- 3:** Negative current is defined as coming out of the pin.

# PIC16C62X

FIGURE 13-3: I<sub>DD</sub> VS. V<sub>DD</sub> (XT OSC 4 MHZ)

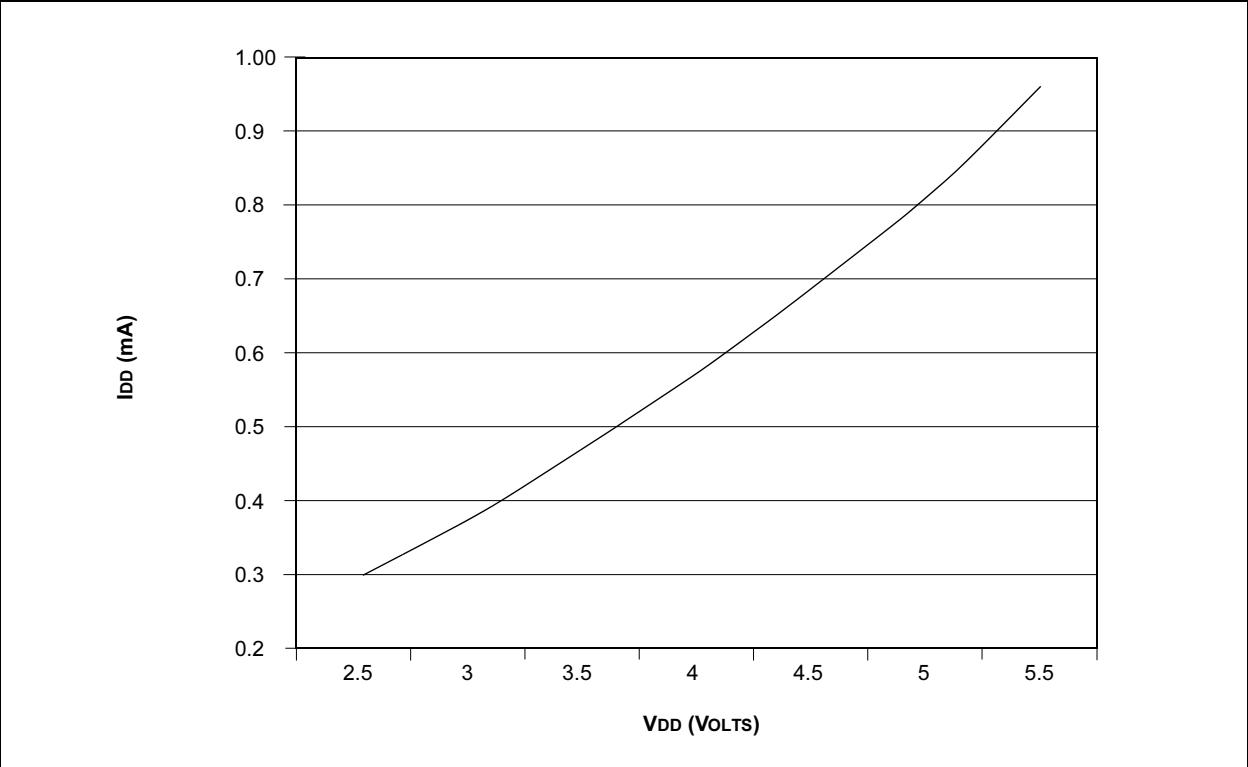
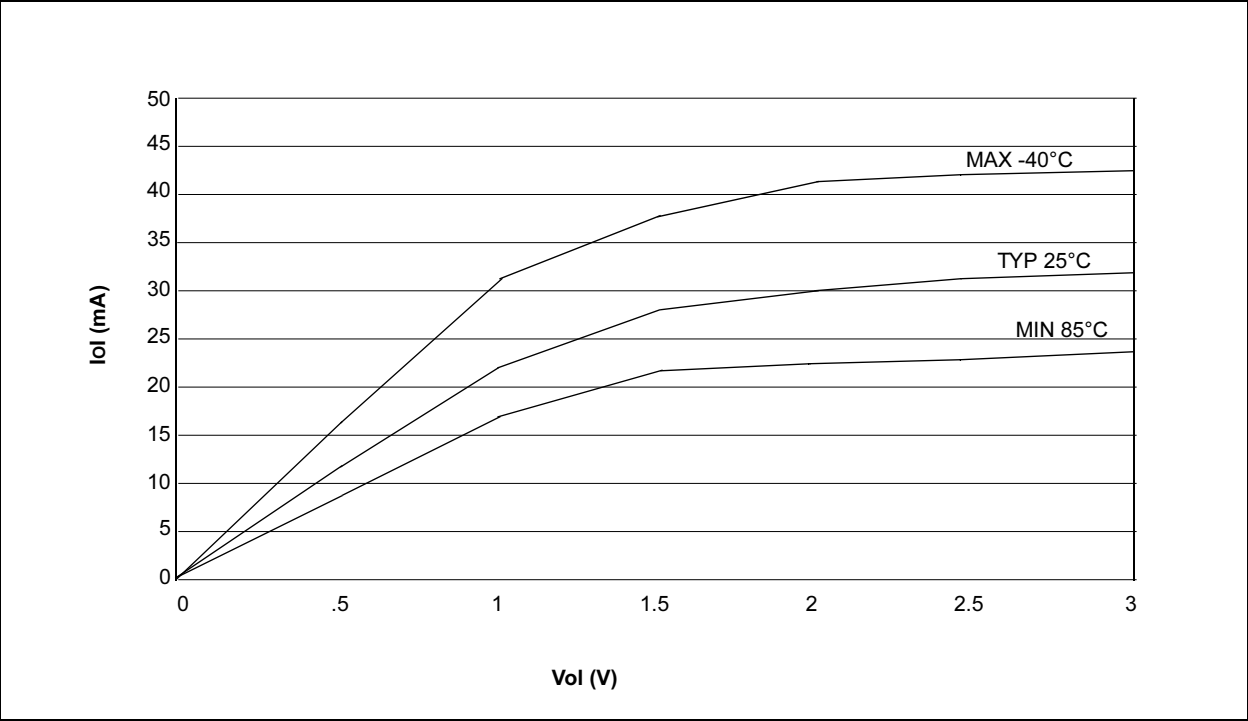
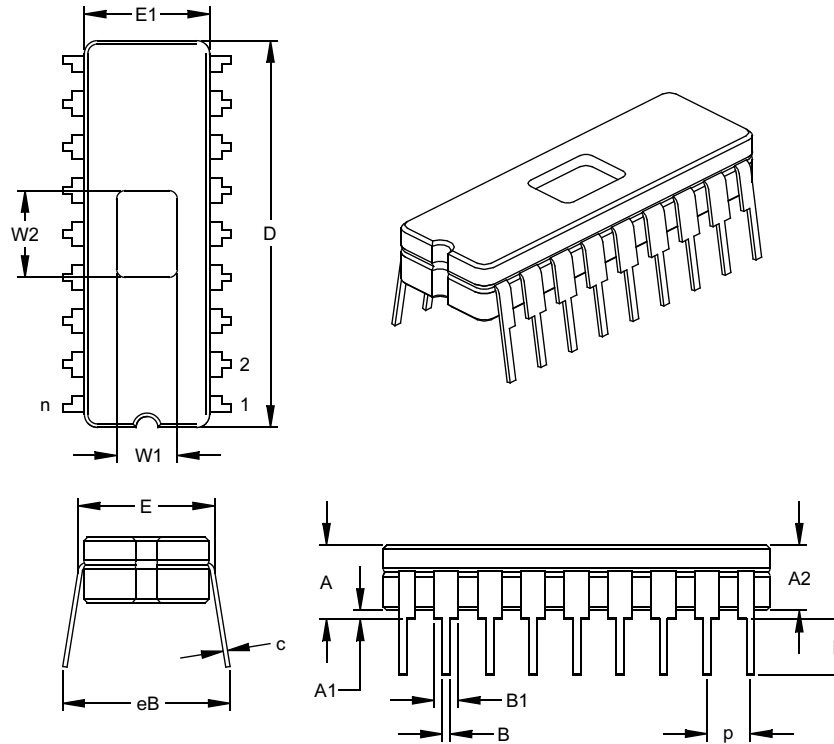


FIGURE 13-4: I<sub>OL</sub> vs. V<sub>OL</sub>, V<sub>DD</sub> = 3.0V



## 14.0 PACKAGING INFORMATION

### 18-Lead Ceramic Dual In-line with Window (JW) – 300 mil (CERDIP)



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		18			18	
Pitch	p		.100			2.54	
Top to Seating Plane	A	.170	.183	.195	4.32	4.64	4.95
Ceramic Package Height	A2	.155	.160	.165	3.94	4.06	4.19
Standoff	A1	.015	.023	.030	0.38	0.57	0.76
Shoulder to Shoulder Width	E	.300	.313	.325	7.62	7.94	8.26
Ceramic Pkg. Width	E1	.285	.290	.295	7.24	7.37	7.49
Overall Length	D	.880	.900	.920	22.35	22.86	23.37
Tip to Seating Plane	L	.125	.138	.150	3.18	3.49	3.81
Lead Thickness	c	.008	.010	.012	0.20	0.25	0.30
Upper Lead Width	B1	.050	.055	.060	1.27	1.40	1.52
Lower Lead Width	B	.016	.019	.021	0.41	0.47	0.53
Overall Row Spacing	§ eB	.345	.385	.425	8.76	9.78	10.80
Window Width	W1	.130	.140	.150	3.30	3.56	3.81
Window Length	W2	.190	.200	.210	4.83	5.08	5.33

\* Controlling Parameter  
 § Significant Characteristic  
 JEDEC Equivalent: MO-036  
 Drawing No. C04-010